



fastPACK 1

650 V / 31 mΩ

Topology features

- Kelvin Emitter for improved switching performance
- Integrated DC capacitor
- Open Emitter configuration
- Temperature sensor

Component features

- Extremely low losses
- Improved reverse diode commutation ruggedness
- Ultra-fast body diode

Housing features

- Base isolation: Al₂O₃
- Convex shaped substrate for superior thermal contact
- Thermo-mechanical push-and-pull force relief
- Press-fit pin
- Reliable cold welding connection

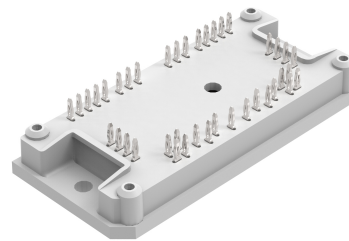
Target applications

- Charging Stations

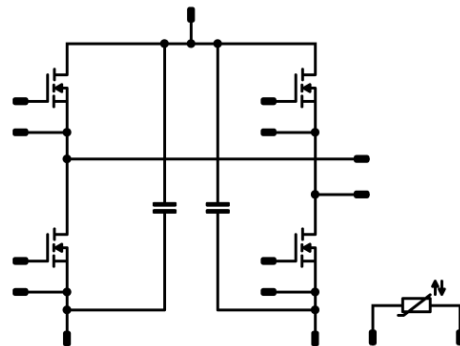
Types

- 10-PY064PA040F7-L581L88Y

flow 1 12 mm housing



Schematic





Vincotech

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

| Parameter | Symbol | Conditions | Value | Unit |
|--------------------------------|------------|---|-------|------|
| Inverter Switch | | | | |
| Drain-source voltage | V_{DS} | | 600 | V |
| Drain current (DC current) | I_D | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 22 | A |
| Peak drain current | I_{DM} | t_p limited by T_{jmax} | 212 | A |
| Avalanche energy, single pulse | E_{AS} | $V_{DD} = 50\text{ V}$ $I_D = 7,4\text{ A}$ | 249 | mJ |
| Avalanche energy, repetitive | E_{AR} | $V_{DD} = 50\text{ V}$ $I_D = 7,4\text{ A}$ | 1,25 | mJ |
| MOSFET dv/dt ruggedness | dv/dt | $V_{DS} = 0..400\text{ V}$ $T_s = 25\text{ °C}$ | 120 | V/ns |
| Total power dissipation | P_{tot} | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 73 | W |
| Gate-source voltage | V_{GSS} | | ±20 | V |
| Reverse diode dv/dt | dv/dt | | 70 | V/ns |
| Maximum Junction Temperature | T_{jmax} | | 150 | °C |

Capacitor (DC)

| | | | | |
|-----------------------|-----------|--|-------------|----|
| Maximum DC voltage | V_{MAX} | | 630 | V |
| Operation Temperature | T_{op} | | -55 ... 125 | °C |

Module Properties

Thermal Properties

| | | | | |
|---|-----------|--|----------------------------|----|
| Storage temperature | T_{stg} | | -40...+125 | °C |
| Operation temperature under switching condition | T_{jop} | | -40...+($T_{jmax} - 25$) | °C |

Isolation Properties

| | | | | |
|----------------------------|------------|-------------------------------------|-------|----|
| Isolation voltage | V_{isol} | DC Test Voltage* $t_p = 2\text{ s}$ | 6000 | V |
| Isolation voltage | V_{isol} | AC Voltage $t_p = 1\text{ min}$ | 2500 | V |
| Creepage distance | | | >12,7 | mm |
| Clearance | | | 7,92 | mm |
| Comparative Tracking Index | CTI | | ≥ 200 | |

*100 % tested in production



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Characteristic Values

| Parameter | Symbol | Conditions | | | | | Values | | | Unit |
|-----------|--------|------------------------------|---|-------------------------------------|------------|-----|--------|-----|--|------|
| | | V_{GE} [V] V_{GS} [V] | V_{CE} [V] V_{DS} [V] V_F [V] | I_C [A] I_D [A] I_F [A] | T_j [°C] | Min | Typ | Max | | |

Inverter Switch

Static

| | | | | | | | | | | |
|----------------------------------|--------------|-------------------|------|-----|---------|-----------|-----|-------------|-------------------|----|
| Drain-source on-state resistance | $r_{DS(on)}$ | | 10 | | 24,9 | 25 125 | | 77,8 143 | 40 ⁽¹⁾ | mΩ |
| Gate-source threshold voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}$ | 0 | | 0,00125 | 25 | 3,5 | 4 | 4,5 | V |
| Gate to Source Leakage Current | I_{GSS} | | 20 | 0 | | 25 | | | 100 | nA |
| Zero Gate Voltage Drain Current | I_{DSS} | | 0 | 600 | | 25 | | | 1 | μA |
| Internal gate resistance | r_g | | | | | | | 3,8 | | Ω |
| Gate charge | Q_g | $V_{DD} = 400$ V | 0/10 | | 14,6 | 25 | | 109 | | nC |
| Short-circuit input capacitance | C_{iss} | $f = 250$ kHz | 0 | 400 | 0 | 25 | | 4354 | | pF |
| Short-circuit output capacitance | C_{oss} | | | | | | | 85 | | |

Thermal

| | | | | | | | | | | |
|--|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|
| Thermal resistance junction to sink ⁽²⁾ | $R_{th(j-s)}$ | $\lambda_{paste} = 3,4$ W/mK (PSX) | | | | | | 0,95 | | K/W |
|--|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|

Dynamic

| | | | | | | | | | | |
|---------------------------------------|----------------------|---------------------------------------|-------|---------|----|-----|--|---------|--|------|
| Turn-on delay time | $t_{d(on)}$ | $R_{gon} = 120$ Ω $R_{goff} = 8$ Ω | -5/10 | 350 | 25 | 25 | | 592,83 | | ns |
| Rise time | t_r | | | | | 125 | | 89,33 | | |
| | | | | | | 125 | | 97,68 | | |
| Turn-off delay time | $t_{d(off)}$ | | | | | 25 | | 98,8 | | |
| | | | | | | 125 | | 107,46 | | |
| Fall time | t_f | | | | | 25 | | 2 | | |
| | | | | | | 125 | | 2,47 | | |
| Turn-on energy (per pulse) | E_{on} | | | | | 25 | | 1,78 | | |
| | | | | | | 125 | | 2,59 | | |
| Turn-off energy (per pulse) | E_{off} | | | | | 25 | | 0,042 | | |
| | | 125 | | 0,049 | | | | | | |
| Peak recovery current | I_{RRM} | 25 | | 27,67 | | | | | | |
| Reverse recovery time | t_{rr} | 125 | | 38,51 | | | | | | |
| | | 25 | | 92,4 | | | | | | |
| Recovered charge | Q_r | 125 | | 139,13 | | | | | | |
| | | 25 | | 1,4 | | | | | | |
| Reverse recovered energy | E_{rec} | 125 | | 2,86 | | | | | | |
| | | 25 | | 0,035 | | | | | | |
| Peak rate of fall of recovery current | $(di_{rr}/dt)_{max}$ | 125 | | 0,074 | | | | | | |
| | | 25 | | 7987,88 | | | | | | |
| | | | | | | 125 | | 6067,26 | | A/μs |



Characteristic Values

| Parameter | Symbol | Conditions | | | | | Values | | | Unit |
|-----------|--------|------------------------------|---|-------------------------------------|------------|-----|--------|-----|--|------|
| | | V_{GE} [V] V_{GS} [V] | V_{CE} [V] V_{DS} [V] V_F [V] | I_C [A] I_D [A] I_F [A] | T_j [°C] | Min | Typ | Max | | |

Capacitor (DC)

Static

| | | | | | | | | | | |
|--------------------|-----|-----------------------|--|--|--|----|-----|-----|----|----|
| Capacitance | C | DC bias voltage = 0 V | | | | 25 | | 100 | | nF |
| Tolerance | | | | | | | -10 | | 10 | % |
| Dissipation factor | | $f = 1$ kHz | | | | 25 | | 2,5 | | % |

Thermistor

Static

| | | | | | | | | | | |
|--------------------------------|----------------|-------------------------|--|--|--|-----|----|------|---|------|
| Rated resistance | R | | | | | 25 | | 22 | | kΩ |
| Deviation of R_{100} | $A_{R/R}$ | $R_{100} = 1484 \Omega$ | | | | 100 | -5 | | 5 | % |
| Power dissipation | P | | | | | 25 | | 130 | | mW |
| Power dissipation constant | d | | | | | 25 | | 1,5 | | mW/K |
| B-value | $B_{(25/50)}$ | Tol. ± 1 % | | | | | | 3962 | | K |
| B-value | $B_{(25/100)}$ | Tol. ± 1 % | | | | | | 4000 | | K |
| Vincotech Thermistor Reference | | | | | | | | | I | |

(1) Value at chip level

(2) Only valid with pre-applied Vincotech thermal interface material.



Inverter Switch Characteristics

figure 1. MOSFET

Typical output characteristics
 $I_D = f(V_{DS})$

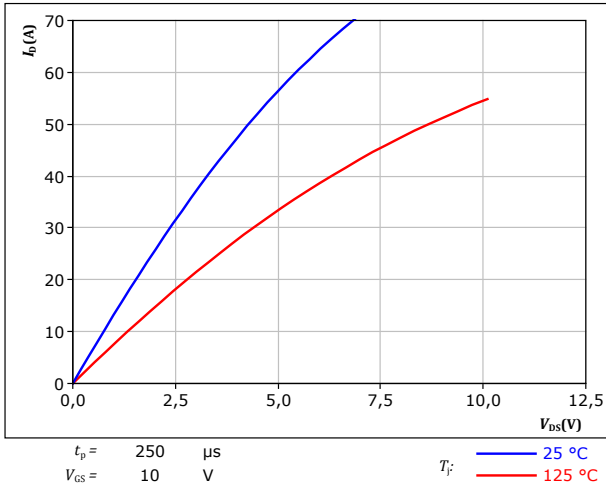


figure 2. MOSFET

Typical output characteristics
 $I_D = f(V_{DS})$

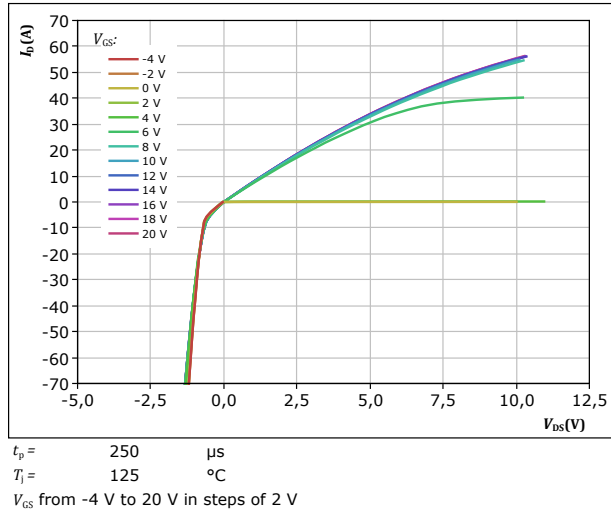


figure 3. MOSFET

Typical transfer characteristics
 $I_D = f(V_{GS})$

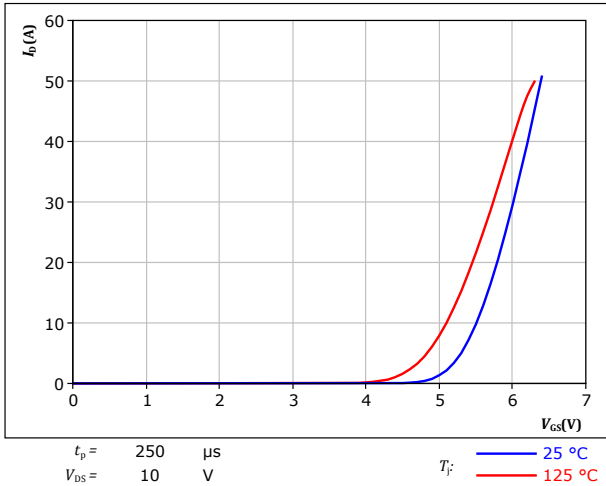
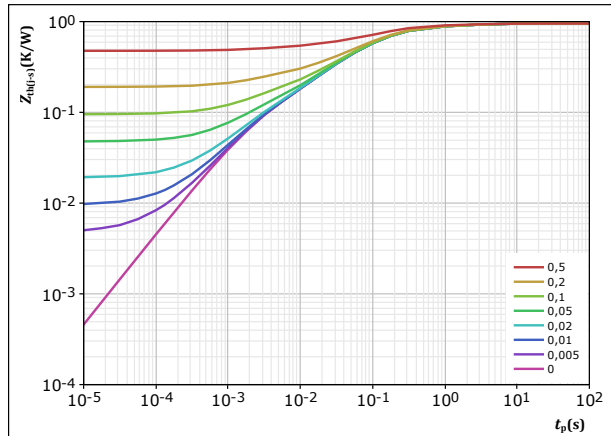


figure 4. MOSFET

Transient thermal impedance as a function of pulse width
 $Z_{th(j-s)} = f(t_p)$



$D = t_p / T$
 $R_{th(j-s)} = 0,953 \text{ K/W}$
 MOSFET thermal model values

| R (K/W) | τ (s) |
|----------|------------|
| 6,96E-02 | 3,02E+00 |
| 1,75E-01 | 4,19E-01 |
| 4,94E-01 | 9,37E-02 |
| 1,49E-01 | 1,82E-02 |
| 6,56E-02 | 2,05E-03 |

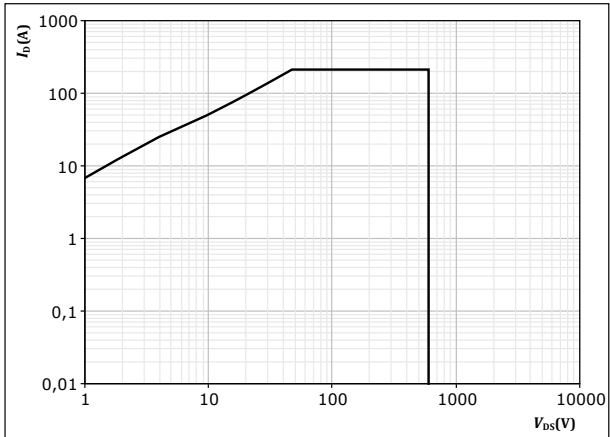


Inverter Switch Characteristics

figure 5. MOSFET

Safe operating area

$$I_D = f(V_{DS})$$



$D =$ single pulse
 $T_s = 80$ °C
 $V_{GS} = 10$ V
 $T_j = T_{jmax}$

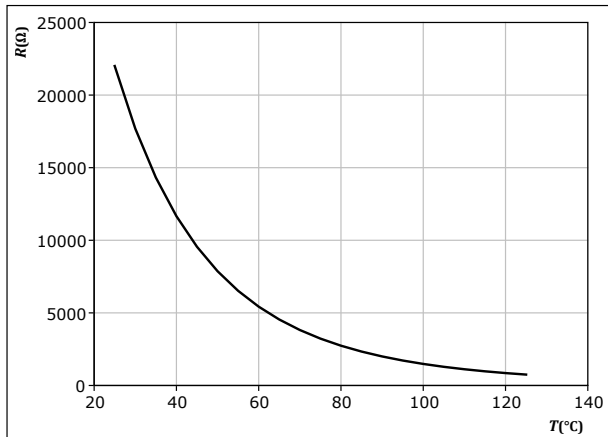


Thermistor Characteristics

figure 6. Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$

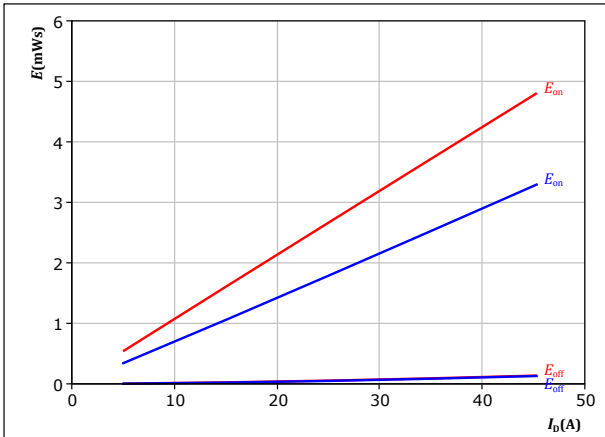




Inverter Switching Characteristics

figure 7. MOSFET

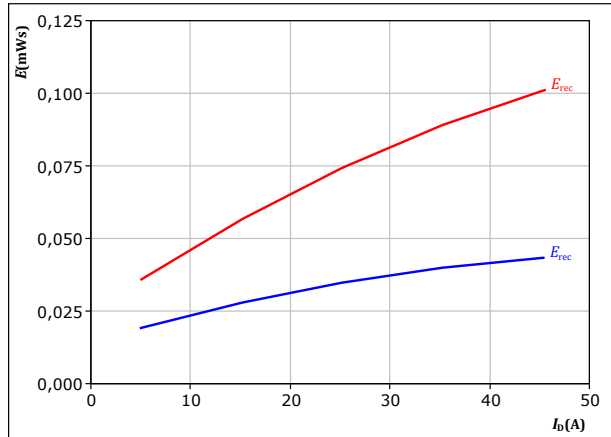
Typical switching energy losses as a function of drain current
 $E = f(I_D)$



With an inductive load at
 $V_{DS} = 350 \text{ V}$
 $V_{GS} = -5/10 \text{ V}$
 $R_{gon} = 120 \text{ } \Omega$
 $R_{goff} = 8 \text{ } \Omega$
 T_j : — 25 °C
 — 125 °C

figure 8. MOSFET

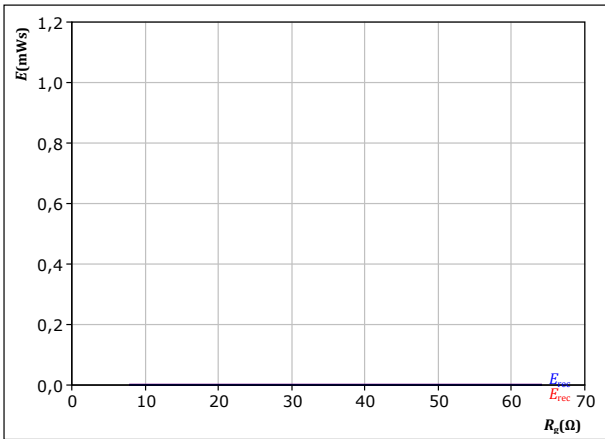
Typical reverse recovered energy loss as a function of drain current
 $E_{rec} = f(I_D)$



With an inductive load at
 $V_{DS} = 350 \text{ V}$
 $V_{GS} = -5/10 \text{ V}$
 $R_{gon} = 120 \text{ } \Omega$
 T_j : — 25 °C
 — 125 °C

figure 9. MOSFET

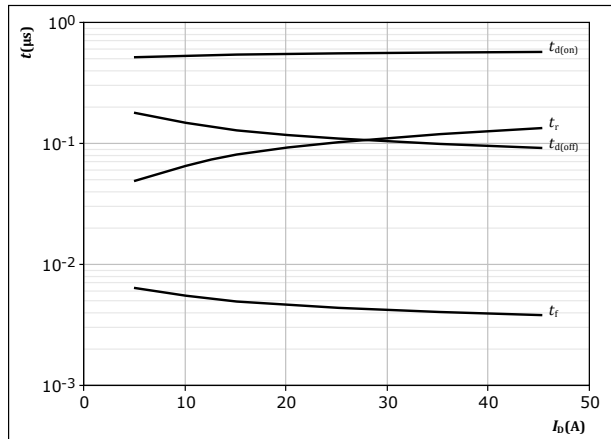
Typical reverse recovered energy loss as a function of MOSFET turn on gate resistor
 $E_{rec} = f(R_g)$



With an inductive load at
 $V_{DS} = 350 \text{ V}$
 $V_{GS} = -5/10 \text{ V}$
 $I_D = 25 \text{ A}$
 T_j : — 25 °C
 — 125 °C

figure 10. MOSFET

Typical switching times as a function of drain current
 $t = f(I_D)$



With an inductive load at
 $T_j = 125 \text{ } ^\circ\text{C}$
 $V_{DS} = 350 \text{ V}$
 $V_{GS} = -5/10 \text{ V}$
 $R_{gon} = 120 \text{ } \Omega$
 $R_{goff} = 8 \text{ } \Omega$

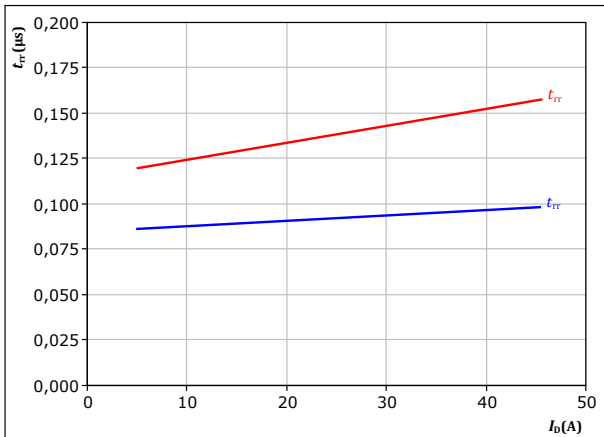


Inverter Switching Characteristics

figure 11. MOSFET

Typical reverse recovery time as a function of drain current

$$t_{rr} = f(I_D)$$

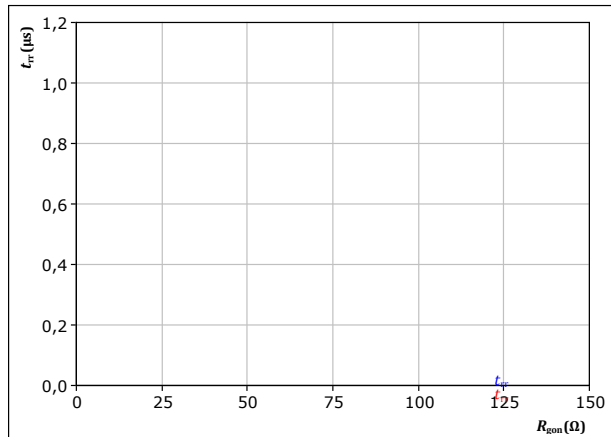


At $V_{DS} = 350$ V
 $V_{GS} = -5/10$ V
 $R_{gon} = 120$ Ω
 T_j : — 25 °C
 — 125 °C

figure 12. MOSFET

Typical reverse recovery time as a function of MOSFET turn on gate resistor

$$t_{rr} = f(R_{gon})$$

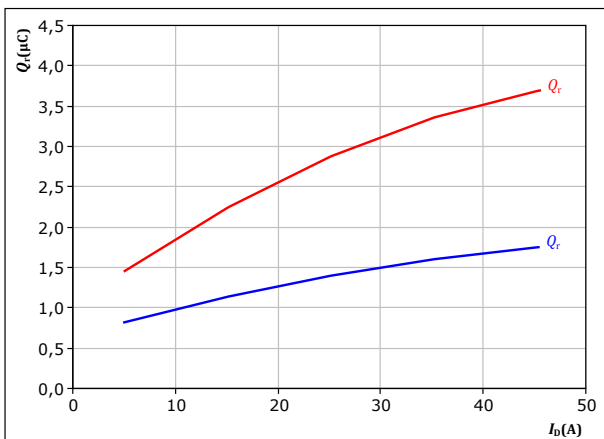


At $V_{DS} = 350$ V
 $V_{GS} = -5/10$ V
 $I_D = 25$ A
 T_j : — 25 °C
 — 125 °C

figure 13. MOSFET

Typical recovered charge as a function of drain current

$$Q_r = f(I_D)$$

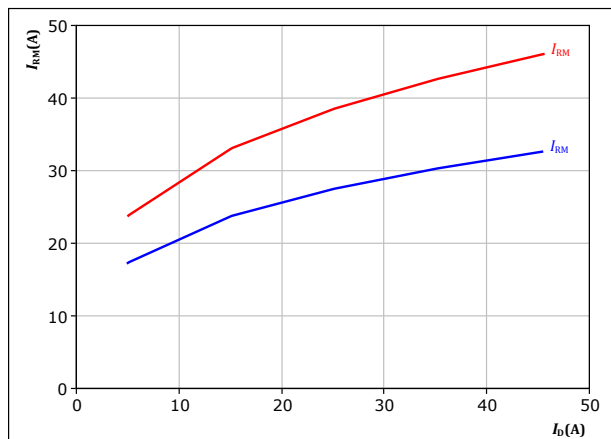


At $V_{DS} = 350$ V
 $V_{GS} = -5/10$ V
 $R_{gon} = 120$ Ω
 T_j : — 25 °C
 — 125 °C

figure 14. MOSFET

Typical peak reverse recovery current as a function of drain current

$$I_{RM} = f(I_D)$$



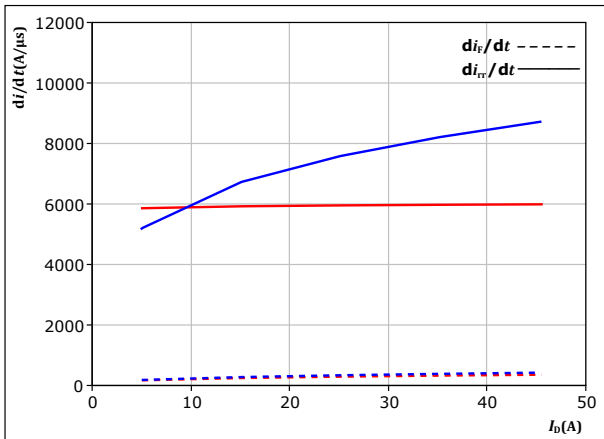
At $V_{DS} = 350$ V
 $V_{GS} = -5/10$ V
 $R_{gon} = 120$ Ω
 T_j : — 25 °C
 — 125 °C



Inverter Switching Characteristics

figure 15. MOSFET

Typical rate of fall of forward and reverse recovery current as a function of drain current
 $di_f/dt, di_{rr}/dt = f(I_D)$

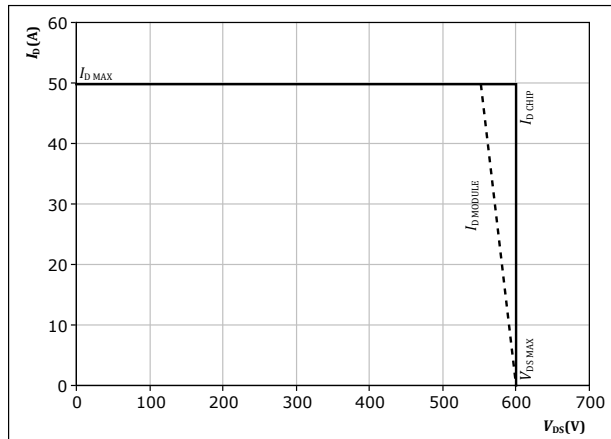


At $V_{DS} = 350$ V
 $V_{GS} = -5/10$ V
 $R_{\theta on} = 120$ Ω

T_f : — 25 °C
— 125 °C

figure 16. MOSFET

Reverse bias safe operating area
 $I_D = f(V_{DS})$



At $T_f = 125$ °C
 $R_{\theta on} = 120$ Ω
 $R_{\theta off} = 8$ Ω



Inverter Switching Definitions

figure 17. MOSFET

Turn-off Switching Waveforms & definition of t_{doff} t_{Eoff} (t_{Eoff} = integrating time for E_{off})

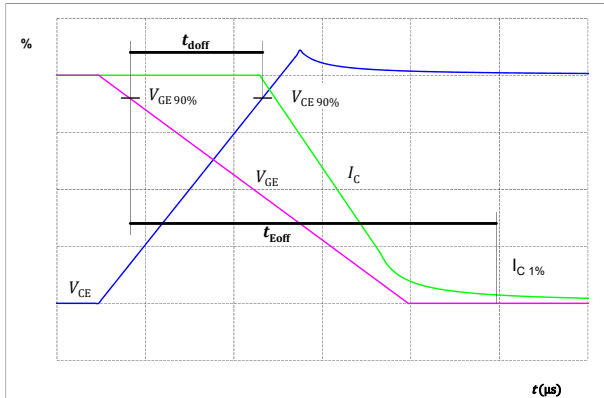


figure 18. MOSFET

Turn-on Switching Waveforms & definition of t_{don} t_{Eon} (t_{Eon} = integrating time for E_{on})

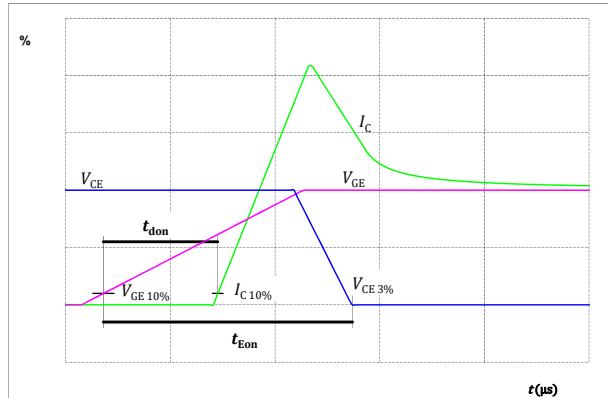


figure 19. MOSFET

Turn-off Switching Waveforms & definition of t_f

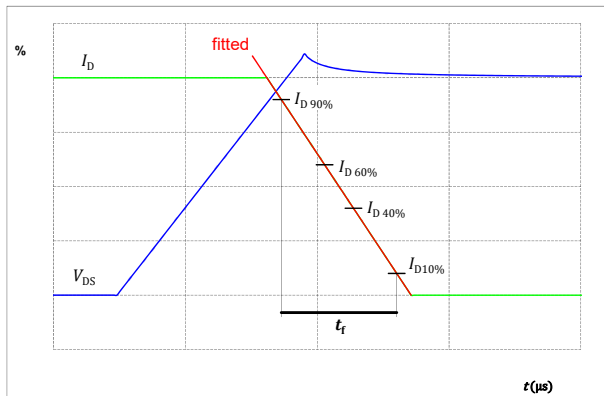
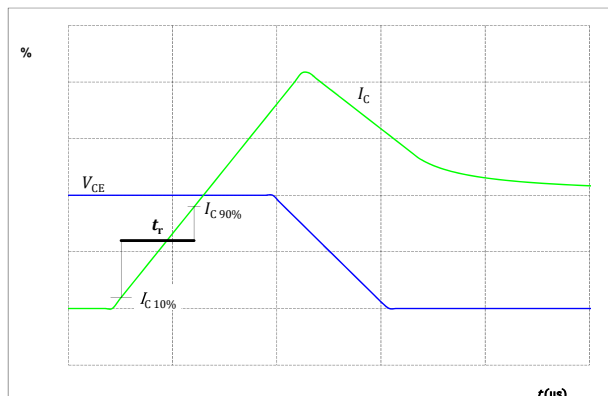


figure 20. MOSFET

Turn-on Switching Waveforms & definition of t_r





Inverter Switching Definitions

figure 21. FWD

Turn-off Switching Waveforms & definition of t_{tr}

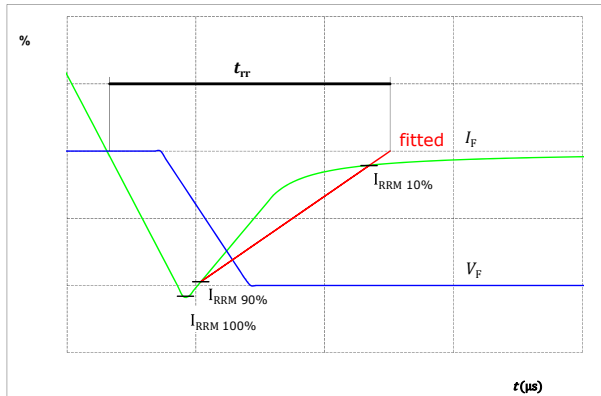


figure 22. FWD

Turn-on Switching Waveforms & definition of t_{Qr} (t_{Qr} = integrating time for Q_r)

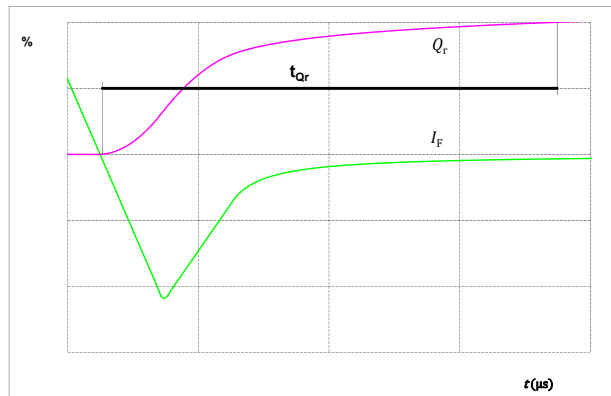
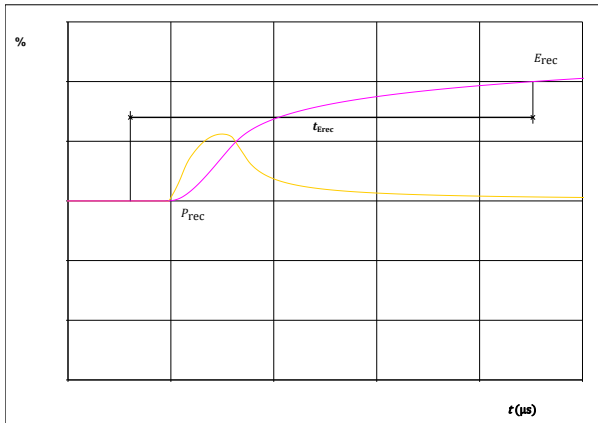


figure 23. FWD

Turn-on Switching Waveforms & definition of t_{Erec} (t_{Erec} = integrating time for E_{rec})





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10-PY064PA040F7-L581L88Y
datasheet

| Ordering Code | |
|--|------------------------------|
| Version | Ordering Code |
| Without thermal paste | 10-PY064PA040F7-L581L88Y |
| With thermal paste (5,2 W/mK, PTM6000HV) | 10-PY064PA040F7-L581L88Y-/7/ |
| With thermal paste (3,4 W/mK, PSX-P7) | 10-PY064PA040F7-L581L88Y-/3/ |

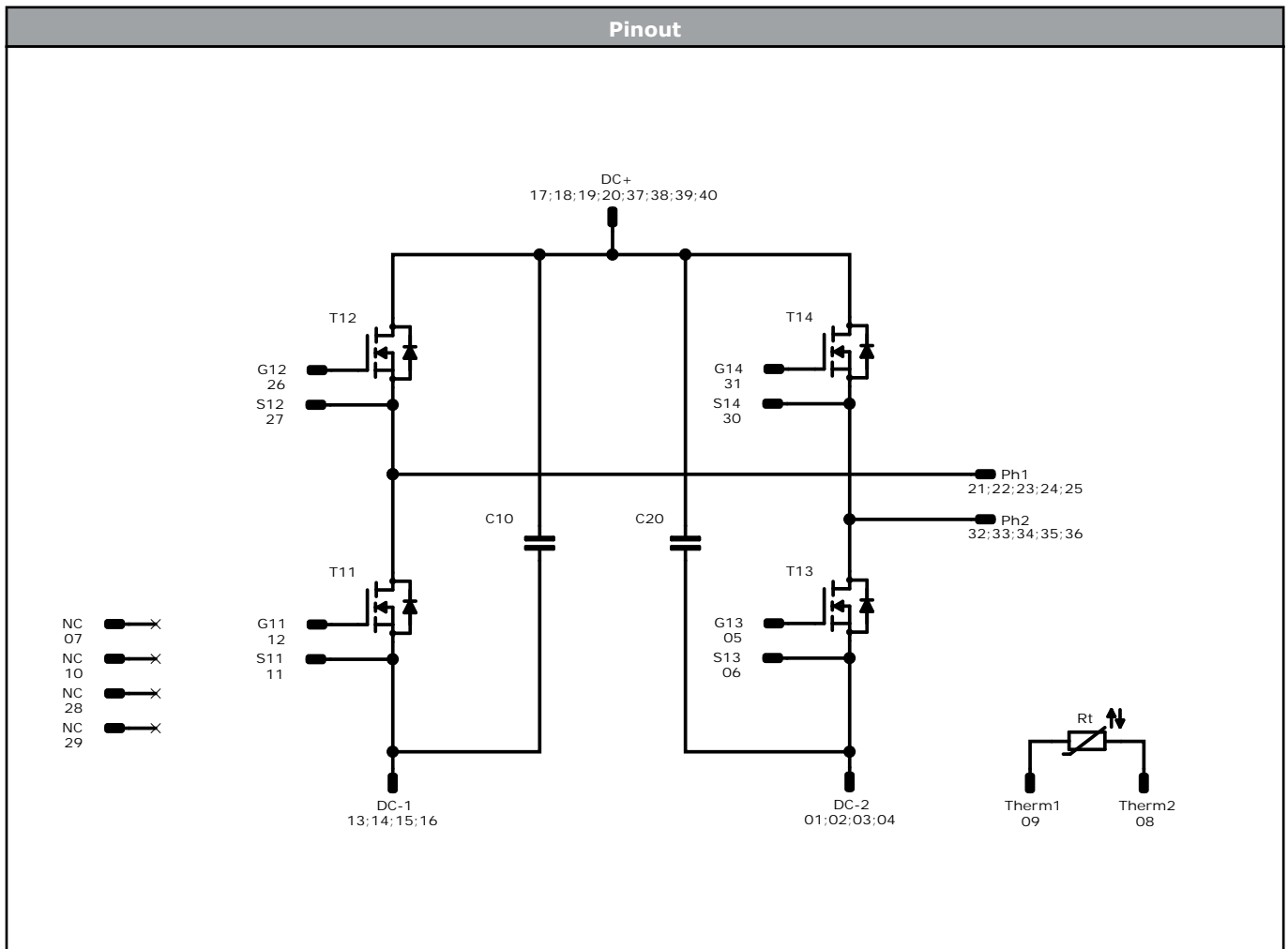
| Marking | | | | | | |
|---------|-------------------|---|----------------------------|-------------------------------|--------------------------|-----------------------|
| | Text | Name NN-NNNNNNNNNNNNNN- TTTTIV | Date code WWYY | UL & VIN UL VIN | Lot LLLLL | Serial SSSS |
| | Datamatrix | Type&Ver TTTTIV | Lot number LLLLL | Serial SSSS | Date code WWYY | |

| Pin table [mm] | | | |
|----------------|-------|------|----------|
| Pin | X | Y | Function |
| 1 | 46,3 | 2,7 | DC-2 |
| 2 | 46,3 | 0 | DC-2 |
| 3 | 43,6 | 2,7 | DC-2 |
| 4 | 43,6 | 0 | DC-2 |
| 5 | 39,2 | 1 | G13 |
| 6 | 36,2 | 0 | S13 |
| 7 | 33,2 | 1 | NC |
| 8 | 28,8 | 0 | Therm2 |
| 9 | 23,8 | 0 | Therm1 |
| 10 | 19,4 | 1 | NC |
| 11 | 16,4 | 0 | S11 |
| 12 | 13,4 | 1 | G11 |
| 13 | 9 | 2,7 | DC-1 |
| 14 | 9 | 0 | DC-1 |
| 15 | 6,3 | 2,7 | DC-1 |
| 16 | 6,3 | 0 | DC-1 |
| 17 | 0 | 6,8 | DC+ |
| 18 | 0 | 9,5 | DC+ |
| 19 | 0 | 12,2 | DC+ |
| 20 | 0 | 14,9 | DC+ |
| 21 | 0 | 28,6 | Ph1 |
| 22 | 2,7 | 28,6 | Ph1 |
| 23 | 5,4 | 28,6 | Ph1 |
| 24 | 8,1 | 28,6 | Ph1 |
| 25 | 10,8 | 28,6 | Ph1 |
| 26 | 15,25 | 28,6 | G12 |
| 27 | 18,25 | 28,6 | S12 |
| 28 | 21,25 | 28,6 | NC |
| 29 | 31,35 | 28,6 | NC |
| 30 | 34,35 | 28,6 | S14 |
| 31 | 37,35 | 28,6 | G14 |
| 32 | 41,8 | 28,6 | Ph2 |
| 33 | 44,5 | 28,6 | Ph2 |
| 34 | 47,2 | 28,6 | Ph2 |
| 35 | 49,9 | 28,6 | Ph2 |
| 36 | 52,6 | 28,6 | Ph2 |
| 37 | 52,6 | 14,9 | DC+ |
| 38 | 52,6 | 12,2 | DC+ |
| 39 | 52,6 | 9,5 | DC+ |
| 40 | 52,6 | 6,8 | DC+ |

Tolerance of pinpositions: ±0,5mm at the end of pins
Dimension of coordinate axis is only offset without tolerance



Vincotech



| Identification | | | | | |
|--------------------|------------|---------|---------|-----------------|---------|
| ID | Component | Voltage | Current | Function | Comment |
| T11, T12, T13, T14 | MOSFET | 600 V | 31 mΩ | Inverter Switch | |
| C10, C20 | Capacitor | 630 V | | Capacitor (DC) | |
| Rt | Thermistor | | | Thermistor | |




Vincotech

| Packaging instruction | | | | |
|---------------------------------------|------|----------|------|--------|
| Standard packaging quantity (SPQ) 100 | >SPQ | Standard | <SPQ | Sample |

| Handling instruction |
|---|
| Handling instructions for <i>flow 1</i> packages see vincotech.com website. |

| Package data |
|--|
| Package data for <i>flow 1</i> packages see vincotech.com website. |

| Vincotech thermistor reference |
|--|
| See Vincotech thermistor reference table at vincotech.com website. |

| UL recognition and file number |
|---|
| This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.  |

| Document No.: | Date: | Modification: | Pages |
|--------------------------------|--------------|---------------|-------|
| 10-PY064PA040F7-L581L88Y-D1-14 | 15 Sep. 2022 | | |

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.